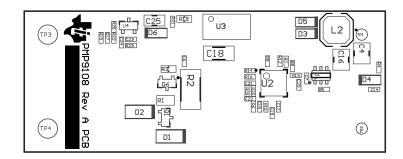


## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9108	REV: A	SVN REV	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 9/5/20	10:29:40	AM	TEXAS INSTRUMENTS



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9108	REV: A	SVN REV: Not In VersionControl
	IGNORE ->		Bottom Overlay
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/5/20	10:29:41	. AM TEXAS INSTRUMENTS

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